TinyLogic HST 2-Input NAND Gate

NC7ST00

Description

The NC7ST00 is a single 2−Input high performance CMOS NAND Gate, with TTL−compatible inputs. Advanced Silicon Gate CMOS fabrication assures high speed and low power circuit operation. ESD protection diodes inherently guard both inputs and output with respect to the V_{CC} and GND rails. High gain circuitry offers high noise immunity and reduced sensitivity to input edge rate. The TTL−compatible inputs facilitate TTL to NMOS / CMOS interfacing. Device performance is similar to MM74HCT but with 1/2 the output current drive of HC / HCT.

Features

- Space Saving SC−74A and SC−88A 5−Lead Package
- Ultra Small MicroPak™ Leadless Package
- High Speed: t_{PD} < 7 ns Typ, V_{CC} = 5 V, C_L = 15 pF
- Low Quiescent Power: I_{CC} < 1 μA Typ, V_{CC} = 5.5 V
- Balanced Output Drive: 2 mA I_{OL}, −2 mA I_{OH}
- TTL−compatible Inputs
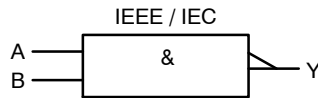- These Devices are Pb−Free, Halogen Free/BFR Free and are RoHS Compliant
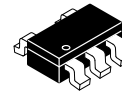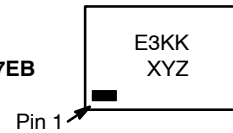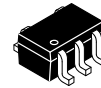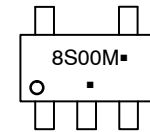

Figure 1. Logic Symbol

ON Semiconductor®

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MARKING DIAGRAMS
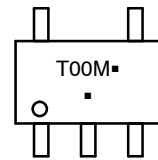

SIP6
CASE 127EB

E3KK
XYZ

Pin 1

SC−74A
CASE 318BQ

8S00M∎

SC−88A
CASE 419A−02

T00M∎

E3, 8S00, T00 = Specific Device Code
KK = 2−Digit Lot Run Traceability Code
XY = 2−Digit Date Code Format
Z = Assembly Plant Code
M = Date Code
∎ = Pb−Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 4 of this data sheet.
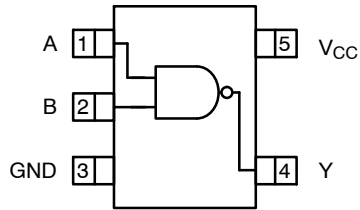
Pin Configurations

Figure 2. SC−88A and SC−74A (Top View)

Figure 3. MicroPak (Top Through View)

PIN DESCRIPTIONS

Pin Names	Description
A, B	Inputs
Y	Output
NC	No Connect

FUNCTION TABLE ($Y = \overline{AB}$)

Inputs		Output
A	**B**	**Y**
L	L	H
L	H	H
H	L	H
H	H	L

H = HIGH Logic Level
L = LOW Logic Level

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter		Min	Max	Unit
V_{CC}	Supply Voltage		−0.5	6.5	V
I_{IK}	DC Input Diode Current	$V_{IN} < 0\ V$	–	−20	mA
		$V_{IN} > V_{CC}$	–	+20	
V_{IN}	DC Input Voltage		−0.5	$V_{CC} + 0.5$	V
I_{OK}	DC Output Diode Current	$V_{OUT} < 0\ V$	–	−20	mA
		$V_{OUT} > V_{CC}$	–	+20	
V_{OUT}	Output Voltage		−0.5	$V_{CC} + 0.5$	V
I_{OUT}	DC Output Source or Sink Current		–	±12.5	mA
I_{CC} or I_{GND}	DC V_{CC} or Ground Current per Supply Pin		–	±25	mA
T_{STG}	Storage Temperature		−65	+150	°C
T_J	Junction Temperature		–	+150	°C
T_L	Lead Temperature (Soldering, 10 Seconds)		–	+260	°C
P_D	Power Dissipation in Still Air	SC−74A	–	390	mW
		SC−88A	–	332	
		MicroPak−6	–	812	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	Supply Voltage		4.5	5.5	V
V_{IN}	Input Voltage		0	V_{CC}	V
V_{OUT}	Output Voltage		0	V_{CC}	V
T_A	Operating Temperature		−40	+85	°C
t_r, t_f	Input Rise and Fall Time	V_{CC} = 5.0 V	0	10	ns/V
θ_{JA}	Thermal Resistance	SC−74A	–	320	°C/W
		SC−88A	–	377	
		MicroPak−6	–	154	

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.
1. Unused inputs must be held HIGH or LOW. They may not float.

DC ELECTICAL CHARACTERISTICS

Symbol	Parameter	V_{CC} (V)	Conditions	T_A = +25°C			T_A = −40 to +85°C		Unit
				Min	Typ	Max	Min	Max	
V_{IH}	HIGH Level Input Voltage	4.5 – 5.5		2.0	–	–	2.0	–	V
V_{IL}	LOW Level Input Voltage	4.5 – 5.5		–	–	0.8	–	0.8	V
V_{OH}	HIGH Level Output Voltage	4.5 4.5	I_{OH} = −20 µA I_{OH} = −2 mA V_{IN} = V_{IH} or V_{IL}	4.4 4.18	4.5 4.35	–	4.4 4.13	–	V
V_{OL}	LOW Level Output Voltage	4.5 4.5	I_{OL} = 20 µA I_{OL} = 2 mA V_{IN} = V_{IH} or V_{IL}	–	0 0.10	0.1 0.26	–	0.1 0.33	V
I_{IN}	Input Leakage Current	5.5	$0 \le V_{IN} \le 5.5$ V	–	–	±0.1	–	±1.0	µA
I_{CC}	Quiescent Supply Current	5.5	V_{IN} = V_{CC} or GND	–	–	1.0	–	10.0	µA
I_{CCT}	I_{CC} per Input	5.5	One Input V_{IN} = 0.5 V or 2.4 V, Other Input V_{CC} or GND	–	–	2.0	–	2.9	mA

AC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	V_{CC} (V)	Conditions	T_A = +25°C			T_A = −40 to +85°C		Unit
				Min	Typ	Max	Min	Max	
t_{PLH}, t_{PHL}	Propagation Delay (Figure 4, 6)	5.0	C_L = 15 pF	–	3.4	12	–	–	ns
				–	6.3	17	–	–	
		4.5	C_L = 50 pF	–	6.0	16	–	20	
				–	11.5	27	–	31	
		5.5		–	4.1	14	–	18	
				–	11.2	26	–	30	
t_{TLH}, t_{THL}	Output Transition Time (Figure 4, 6)	5.0	C_L = 15 pF	–	4	10	–	–	ns
		4.5	C_L = 50 pF	–	11	25	–	31	
		5.5		–	10	21	–	26	
C_{IN}	Input Capacitance	Open		–	2	10	–	–	pF
C_{PD}	Power Dissipation Capacitance (Figure 5)	5.0	(Note 2)	–	6	–	–	–	pF

2. C_{PD} is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current. Current consumption (I_{CCD}) at no output loading and operating at 50% duty cycle. (See Figure 5). C_{PD} is related to I_{CCD} dynamic operating current by the expression: $I_{CCD} = (C_{PD})(V_{CC})(f_{IN}) + (I_{CCstatic})$.

AC Loading and Waveforms
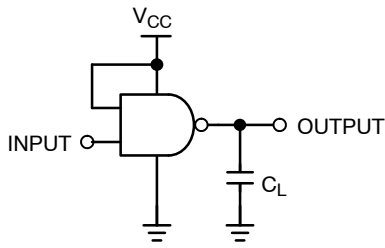
C_L includes load and stray capacitance
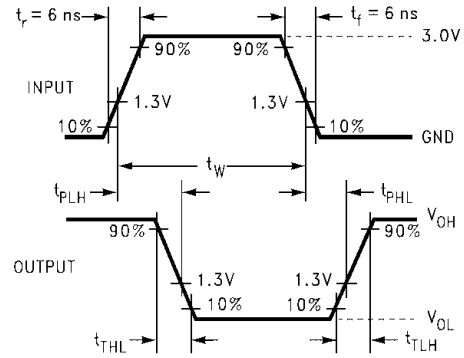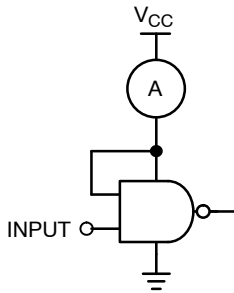Input PRR = 1.0 MHz, t_W = 500 ns

Figure 4. AC Test Circuit

Figure 6. AC Waveforms

Input = AC Waveform;
PRR = Variable; Duty Cycle = 50%.

Figure 5. I_{CCD} Test Circuit

ORDERING INFORMATION

Device	Top Mark	Packages	Shipping†
NC7ST00M5X	8S00	SC−74A	3000 / Tape & Reel
NC7ST00P5X	T00	SC−88A	3000 / Tape & Reel
NC7ST00L6X	E3	SIP6, MicroPak	5000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

SIP6 1.45X1.0
CASE 127EB
ISSUE O

DATE 31 AUG 2016

2X

0.05 C

1.45

B

2X

0.05 C

(0.254)

1.00

PIN 1 IDENTIFIER

5

TOP VIEW

A

(1)

(0.49)
5X

(0.75)

(0.52)
1X

(0.30)
6X

PIN 1

RECOMMENED
LAND PATTERN

0.50±0.05

0.05
0.00

0.05 C

C

0.35±0.05

1.45±0.05

DETAIL A

1.0

0.20±0.05   6X

0.10 M C B A
0.05 M C

0.30±0.05   5X

1.00±0.05

0.35±0.05   5X

(0.050)
6X

0.5

(0.125)
4X

BOTTOM VIEW

0.40±0.05

0.075 X 45°
CHAMFER

DETAIL A
PIN 1 TERMINAL
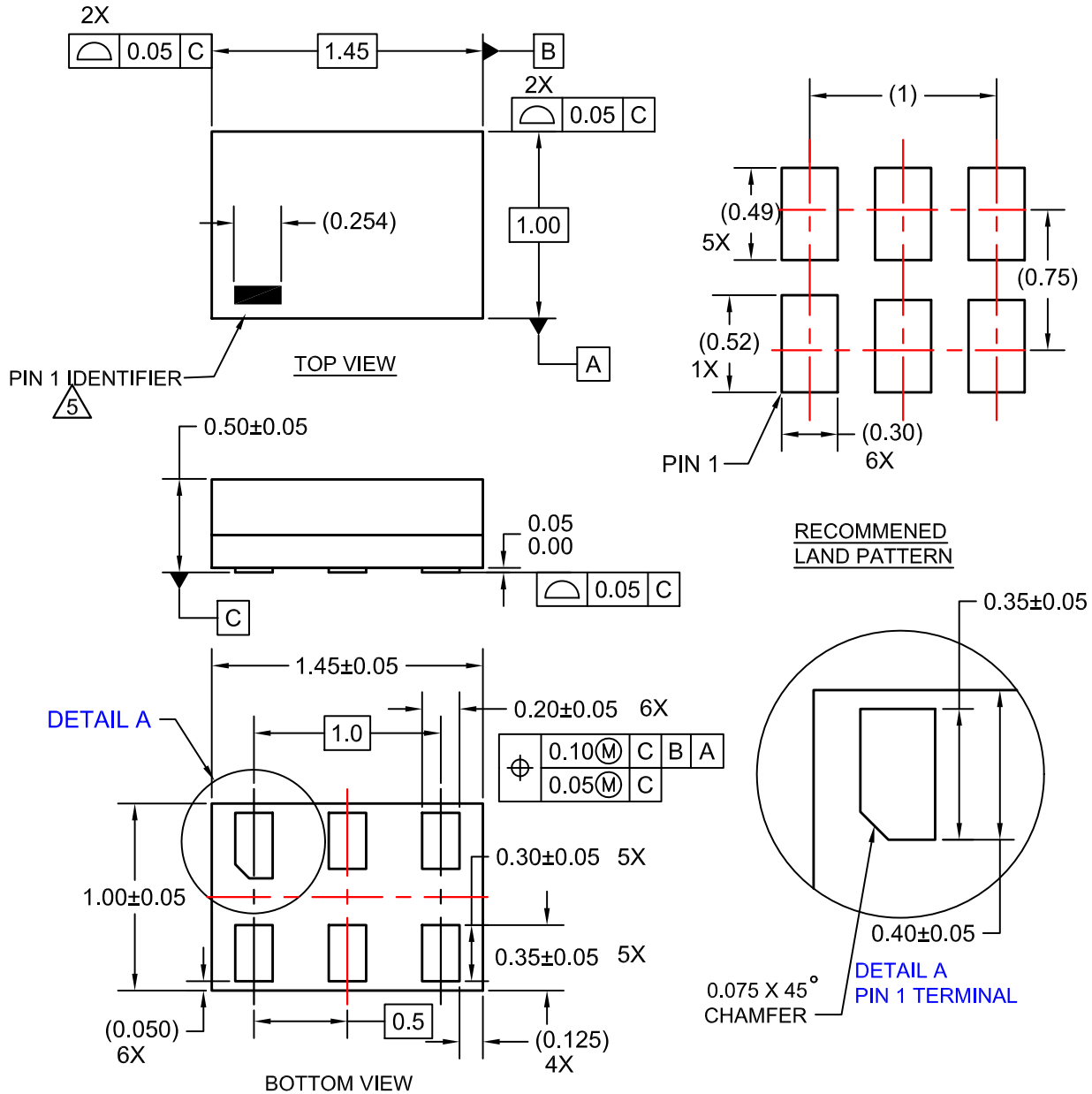
NOTES:

1. CONFORMS TO JEDEC STANDARD MO-252 VARIATION UAAD
2. DIMENSIONS ARE IN MILLIMETERS
3. DRAWING CONFORMS TO ASME Y14.5M-2009
4. PIN ONE IDENTIFIER IS 2X LENGTH OF ANY OTHER LINE IN THE MARK CODE LAYOUT.

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DESCRIPTION:	SIP6 1.45X1.0		PAGE 1 OF 1

SC−74A
CASE 318BQ
ISSUE B

DATE 18 JAN 2018

5

1

SCALE 2:1

5X **b**

⊕ | 0.20 | C A B

E1

5   4

1   2   3

B

A | D

e

E

TOP VIEW

0.05 | A1

L | M

DETAIL A

A

C **SEATING PLANE**

SIDE VIEW

DETAIL A

c

END VIEW
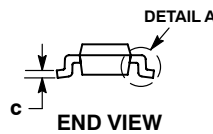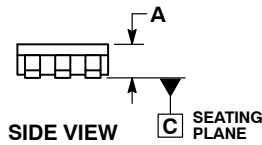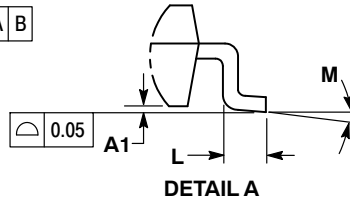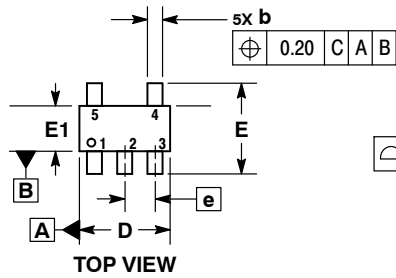
NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
4. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.15 PER SIDE.

DIM	MILLIMETERS	
	MIN	MAX
A	0.90	1.10
A1	0.01	0.10
b	0.25	0.50
c	0.10	0.26
D	2.85	3.15
E	2.50	3.00
E1	1.35	1.65
e	0.95 BSC	
L	0.20	0.60
M	0 °	10 °

**RECOMMENDED
SOLDERING FOOTPRINT***
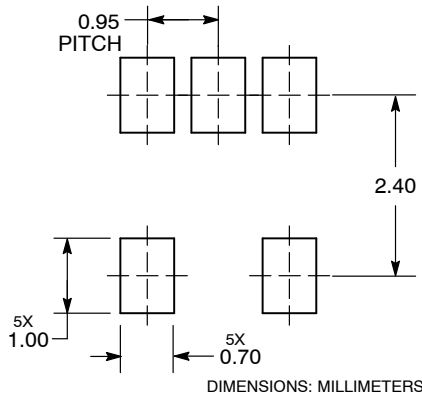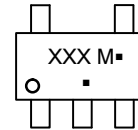
0.95
PITCH

2.40

5X
1.00

5X
0.70

DIMENSIONS: MILLIMETERS

**GENERIC
MARKING DIAGRAM***

XXX M∎

XXX = Specific Device Code
M = Date Code
∎ = Pb−Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, "G" or microdot " ∎", may or may not be present. Some products may not follow the Generic Marking.

*For additional information on our Pb−Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

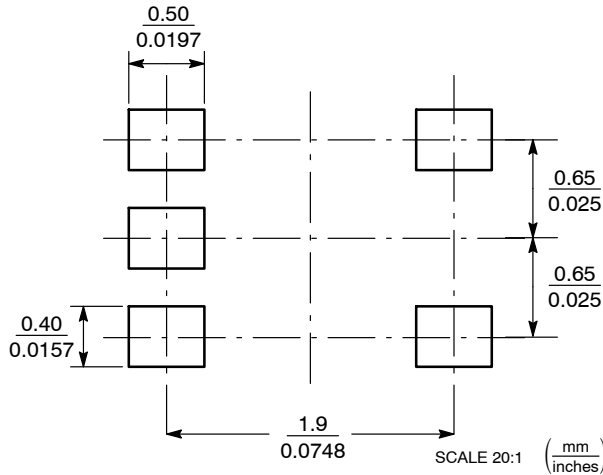| DOCUMENT NUMBER:	98AON66279G	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.	
DESCRIPTION:	SC−74A		PAGE 1 OF 1

SC−88A (SC−70−5/SOT−353)
CASE 419A−02
ISSUE L

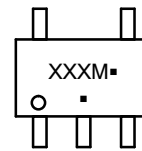DATE 17 JAN 2013

SCALE 2:1

NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. 419A−01 OBSOLETE. NEW STANDARD 419A−02.
4. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

DIM	INCHES MIN	INCHES MAX	MILLIMETERS MIN	MILLIMETERS MAX
A	0.071	0.087	1.80	2.20
B	0.045	0.053	1.15	1.35
C	0.031	0.043	0.80	1.10
D	0.004	0.012	0.10	0.30
G	0.026 BSC		0.65 BSC	
H	---	0.004	---	0.10
J	0.004	0.010	0.10	0.25
K	0.004	0.012	0.10	0.30
N	0.008 REF		0.20 REF	
S	0.079	0.087	2.00	2.20

D 5 PL ⊕ 0.2 (0.008) Ⓜ B Ⓜ

SOLDER FOOTPRINT

0.50 / 0.0197

0.65 / 0.025

0.65 / 0.025

0.40 / 0.0157

1.9 / 0.0748

SCALE 20:1   (mm / inches)

GENERIC MARKING DIAGRAM*

XXXM▪

XXX = Specific Device Code
M   = Date Code
▪   = Pb−Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

STYLE 1:
PIN 1. BASE
2. EMITTER
3. BASE
4. COLLECTOR
5. COLLECTOR

STYLE 2:
PIN 1. ANODE
2. EMITTER
3. BASE
4. COLLECTOR
5. CATHODE

STYLE 3:
PIN 1. ANODE 1
2. N/C
3. ANODE 2
4. CATHODE 2
5. CATHODE 1

STYLE 4:
PIN 1. SOURCE 1
2. DRAIN 1/2
3. SOURCE 1
4. GATE 1
5. GATE 2

STYLE 5:
PIN 1. CATHODE
2. COMMON ANODE
3. CATHODE 2
4. CATHODE 3
5. CATHODE 4

STYLE 6:
PIN 1. EMITTER 2
2. BASE 2
3. EMITTER 1
4. COLLECTOR
5. COLLECTOR 2/BASE 1

STYLE 7:
PIN 1. BASE
2. EMITTER
3. BASE
4. COLLECTOR
5. COLLECTOR

STYLE 8:
PIN 1. CATHODE
2. COLLECTOR
3. N/C
4. BASE
5. EMITTER

STYLE 9:
PIN 1. ANODE
2. CATHODE
3. ANODE
4. ANODE
5. ANODE

Note: Please refer to datasheet for style callout. If style type is not called out in the datasheet refer to the device datasheet pinout or pin assignment.

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DESCRIPTION:	SC−88A (SC−70−5/SOT−353)	PAGE 1 OF 1